

1. General description

WSJ2M60R065DX is a high voltage N-channel MOSFET in TO220F package, which utilizes the advanced super-junction technology to provide superior FOM $R_{DS(on)} \cdot Q_g$ among silicon based MOSFETs. It is particularly suitable for applications require extreme high efficiency and power density.



2. Features and benefits

- Superior FOM $R_{DS(on)} \cdot Q_g$
- Extremely low switching loss
- Integrated ultrafast body diode
- 100% avalanche tested

3. Applications

- Telecom and server power supplies
- LED lighting
- LEV charger
- LLC applications

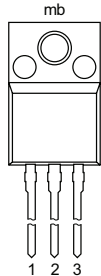
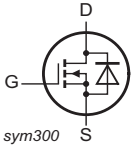
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute maximum rating							
V _{DS}	drain-source voltage			600			V
V _{GS}	gate-source voltage	static		±20			V
V _{GS}	gate-source voltage	dynamic AC (f > 1 HZ)		±30			V
I _D	continuous drain current	T _C = 25 °C	[1]	42			A
P _{tot}	power dissipation	T _C = 25 °C		31			W
T _j	junction temperature			-55 to 150			°C
Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
R _{DS(on)}	drain-source on-state resistance	V _{GS} = 10 V, I _D = 21 A		-	54	65	mΩ
Dynamic characteristics							
Q _{G(tot)}	total gate charge	I _D = 21 A; V _{DS} = 400 V; V _{GS} = 10 V		-	82	-	nC
E _{OSS}	coss stored energy	V _{GS} = 0 V; V _{DS} = 0 to 400 V		-	9.4	-	μJ

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	D	drain		
3	S	source		
mb	n.c.	mounting base; isolated		

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WSJ2M60R065DX	TO220F	WSJ2M60R065DXQ	Tube	50	SOT186A	14-Nov-2013

7. Marking

Table 4. Marking codes

Type number	Marking codes
WSJ2M60R065DX	WSJ2M 60R065DX

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V_{DS}	drain-source voltage			600	V
V_{GS}	gate-source voltage	static		± 20	V
V_{GS}	gate-source voltage	dynamic AC ($f > 1$ Hz)		± 30	V
I_D	continuous drain current	$T_C = 25\text{ }^{\circ}\text{C}$	[1]	42	A
		$T_C = 100\text{ }^{\circ}\text{C}$	[1]	27	A
I_{DM}	pulsed drain current	$T_C = 25\text{ }^{\circ}\text{C}$		168	A
P_{tot}	power dissipation	$T_C = 25\text{ }^{\circ}\text{C}$		31	W
E_{AS}	single pulse drain-to-source avalanche	$I_{AS} = 8.4\text{ A}$; $R_{GS} = 25\text{ }\Omega$; $V_{DD} = 50\text{ V}$; $T_j = 25\text{ }^{\circ}\text{C}$		352	mJ
E_{AR}	repetitive avalanche energy	$I_{AS} = 8.4\text{ A}$; $R_{GS} = 25\text{ }\Omega$; $V_{DD} = 50\text{ V}$; $T_j = 25\text{ }^{\circ}\text{C}$		1.98	mJ
I_{AS}	avalanche current, single pulse			8.4	A
dv/dt	MOSFET dv/dt ruggedness			120	V/ns
dv/dt	reverse diode dv/dt			60	V/ns
dI _F /dt	maximum diode commutation speed			1000	A/ μ s
T_{stg}	storage temperature			-55 to 150	$^{\circ}\text{C}$
T_j	junction temperature			-55 to 150	$^{\circ}\text{C}$

Notes: Limited by maximum junction temperature, equivalent to TO220.

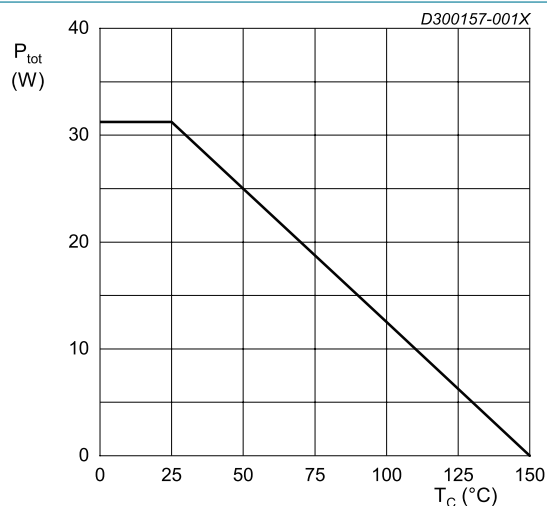


Fig. 1. Total power dissipation as a function of case temperature

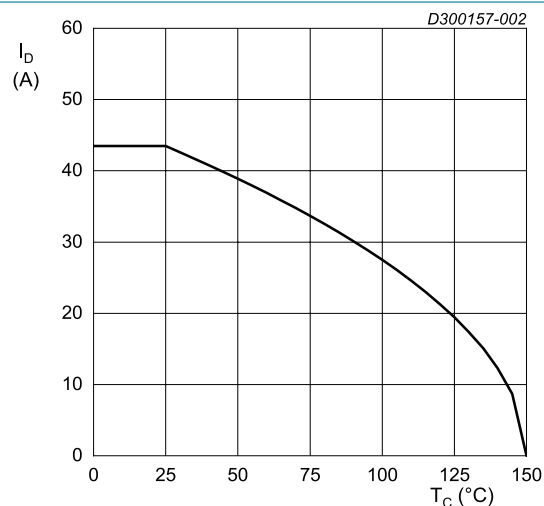


Fig. 2. Continuous Drain Current as a function of case temperature

9. Thermal & Mechanical characteristics

Table 6. Thermal & Mechanical characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
$R_{th(j-c)}$	thermal resistance from junction to case			-	2.9	4.0	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air		-	60	-	K/W

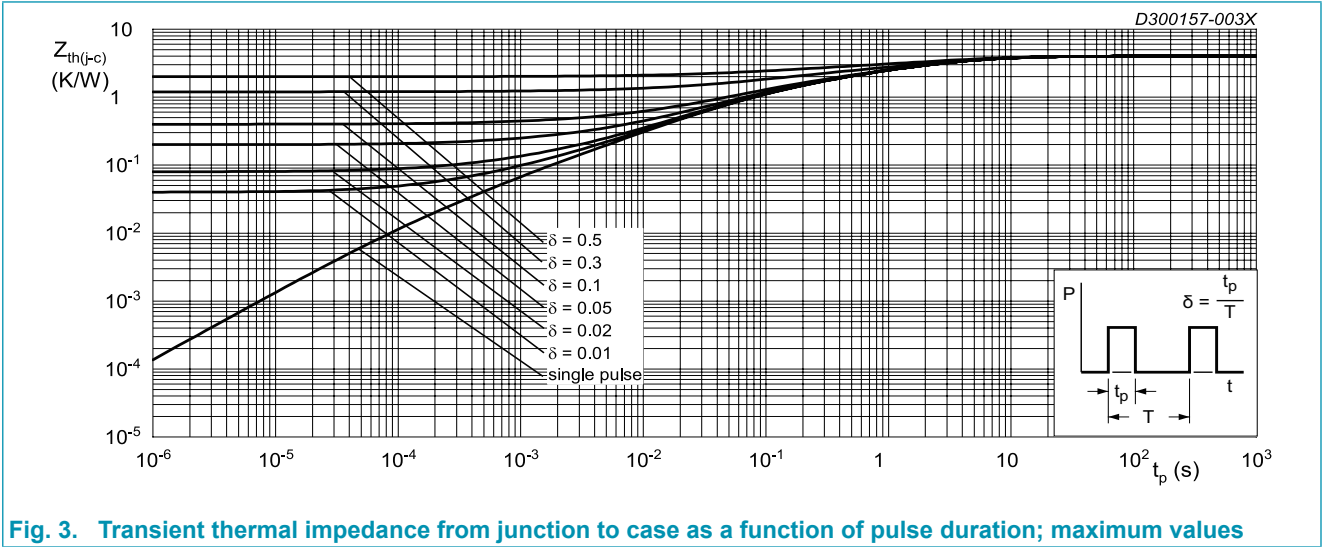


Fig. 3. Transient thermal impedance from junction to case as a function of pulse duration; maximum values

10. Characteristics

Table 7. Characteristics
 $T_j = 25\text{ }^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
V _{(BR)DSS}	drain-source breakdown voltage	I _D = 1 mA; V _{GS} = 0 V		600	-	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 250 μA; V _{DS} = V _{GS}		3.0	-	5.0	V
I _{DSS}	drain leakage current	V _{DS} = 600 V; V _{GS} = 0 V		-	-	10	μA
		V _{DS} = 600 V; V _{GS} = 0 V; T _J = 125 °C		-	200	-	μA
I _{GSS}	gate leakage current	V _{GS} = ±20 V; V _{DS} = 0 V		-	-	±100	nA
R _{DS(on)}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 21 A		-	54	65	mΩ
R _G	gate resistance	f = 1 MHz		-	1.3	-	Ω
Dynamic characteristics							
Q _{G(tot)}	total gate charge	I _D = 21 A; V _{DS} = 400 V; V _{GS} = 10 V		-	82	-	nC
Q _{GS}	gate-source charge			-	28	-	nC
Q _{GD}	gate-drain charge			-	34	-	nC
C _{iss}	input capacitance	V _{DS} = 400 V; V _{GS} = 0 V; f = 1 MHz		-	3368	-	pF
C _{oss}	output capacitance			-	61	-	pF
C _{rss}	reverse transfer capacitance			-	2.0	-	pF
C _{o(er)}	effective output capacitance, energy related	V _{GS} = 0 V; V _{DS} = 0 to 400 V		-	117	-	pF
C _{o(tr)}	effective output capacitance, time related			-	1021	-	pF
t _{d(on)}	turn-on delay time	V _{DS} = 400 V; V _{GS} = 10 V; R _G = 5 Ω; I _D = 21 A		-	62	-	ns
t _r	rise time			-	12	-	ns
t _{d(off)}	turn-off delay time			-	73	-	ns
t _f	fall time			-	3.5	-	ns
Source-drain diode							
V _{SD}	source-drain voltage	V _{GS} = 0 V; I _S = 21 A		-	1.0	1.2	V
I _S	body-diode continuous current	T _C = 25 °C		-	-	31	A
t _{rr}	reverse recovery time	V _R = 400 V; I _F = 21 A; dI _F /dt = 100 A/μs		-	123	-	ns
Q _{rr}	reverse recovered charge			-	0.7	-	μC
I _{rrm}	reverse recovery current			-	11	-	A

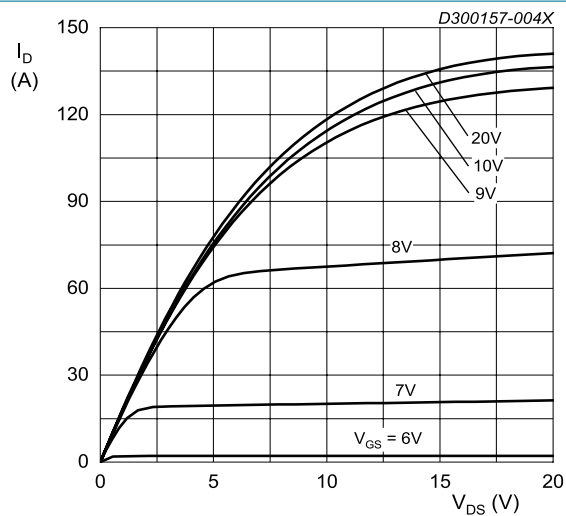


Fig. 4. Drain current as a function of drain-source voltage; typical values

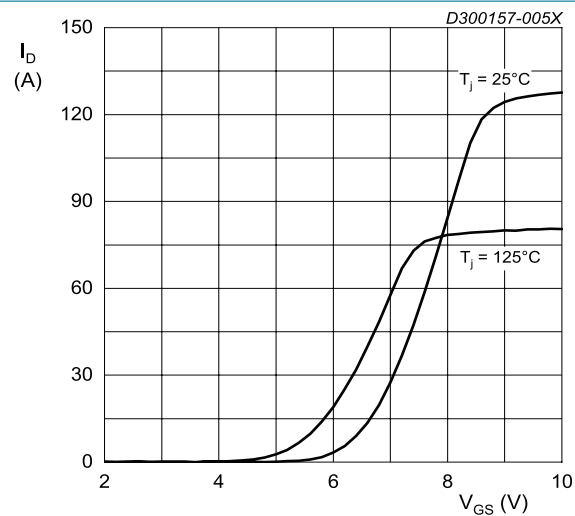


Fig. 5. Drain current as a function of gate-source voltage; typical values

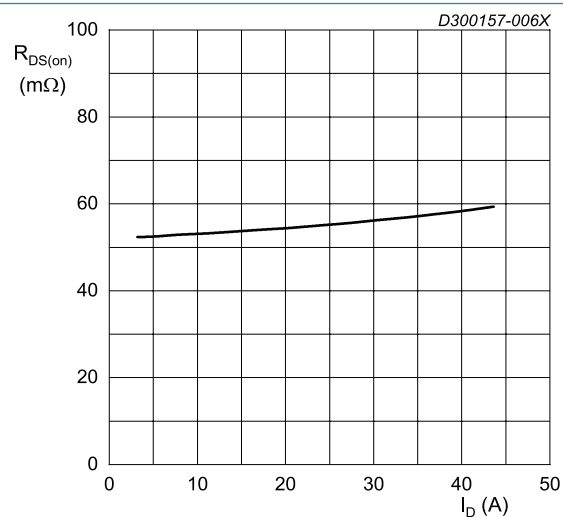


Fig. 6. Drain-source on-state resistance as a function of drain current; typical values

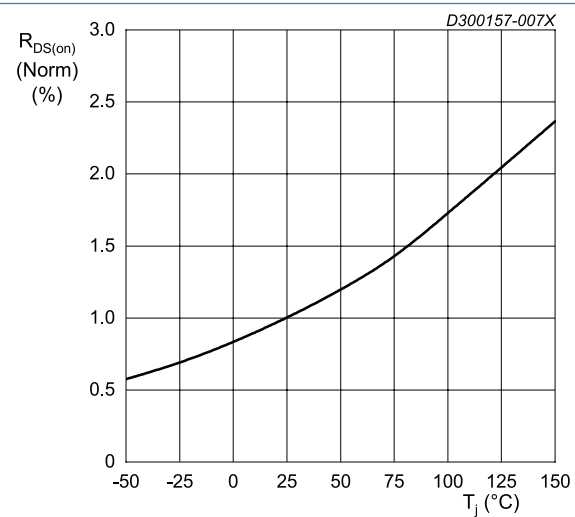
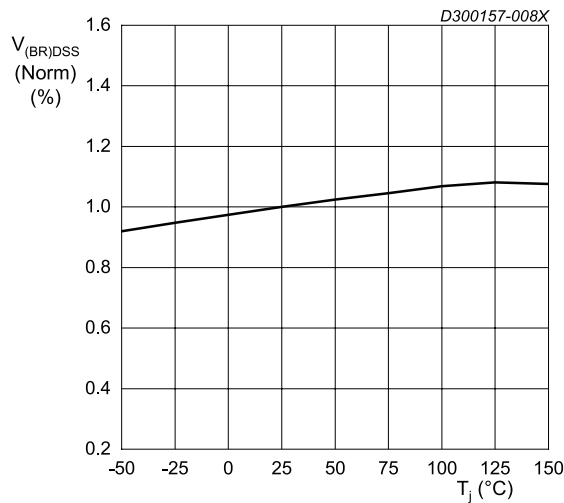
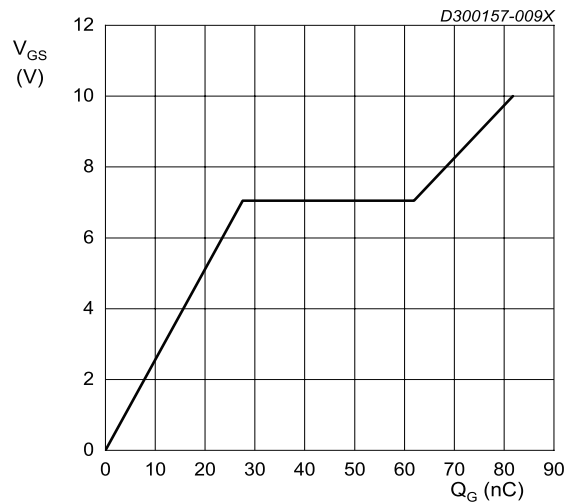


Fig. 7. Normalized drain-source on-state resistance as a function of junction temperature



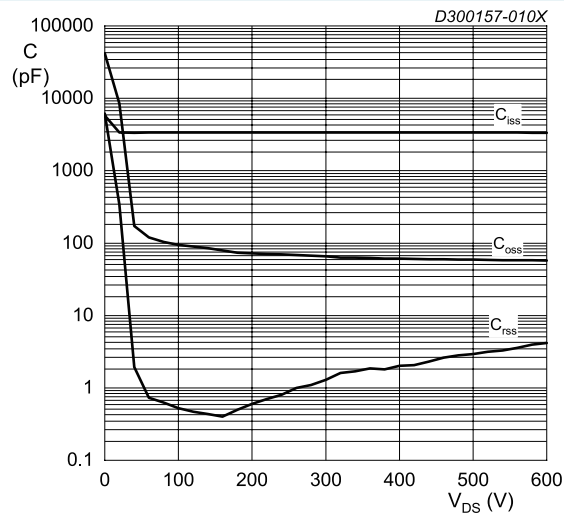
$I_D = 5 \text{ mA}$

Fig. 8. Normalized drain-source breakdown voltage as a function of junction temperature



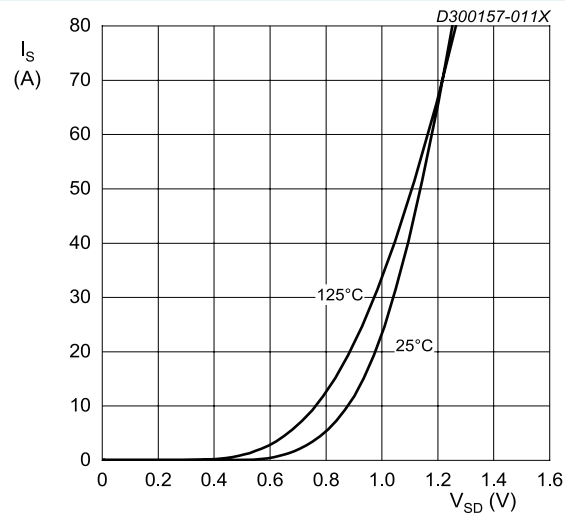
$I_D = 21 \text{ A}; V_{DS} = 400 \text{ V}$

Fig. 9. Gate-source voltage as a function of gate charge; typical values



$V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$

Fig. 10. Capacitances as a function of drain-source voltage; typical values



$V_{GS} = 0 \text{ V}$

Fig. 11. Source current as a function of source-drain voltage; typical values

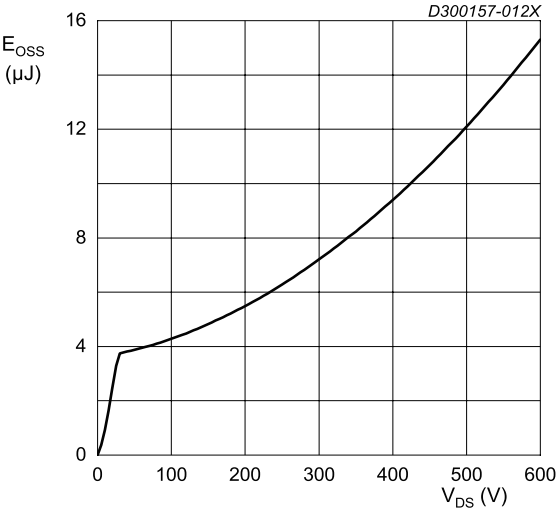


Fig. 12. Output capacitance stored energy as a function of drain-source voltage

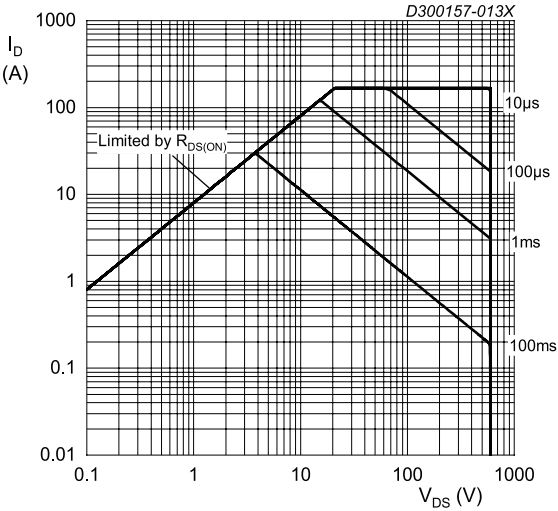
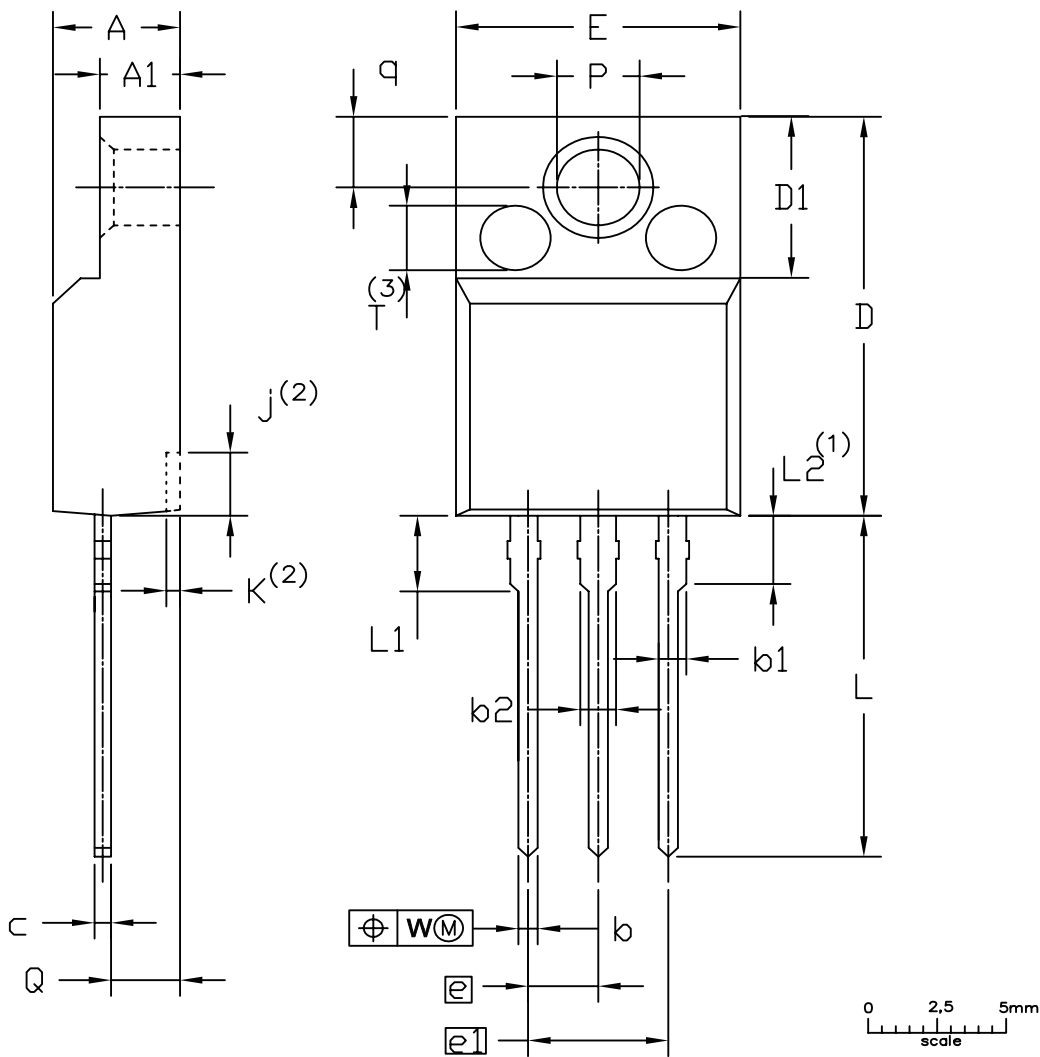


Fig. 13. Safe operating area
 $T_C = 25^\circ C$

11. Package outline

Plastic single-ended package;isolated heatsink mounted;1 mounting hole;3-lead TO-220 "full pack"

SOT186A



UNIT	A	A ₁	b	b ₁	b ₂	c	D	D ₁	E	e	e ₁	j ⁽²⁾	k ⁽²⁾	L	L ₁	L ₂ ⁽¹⁾ max.	P	Q	q	W	T ⁽³⁾
mm	4.6	2.9	0.9	1.1	1.4	0.7	15.8	6.5	10.3	2.54	5.08	2.7	0.6	14.4	3.30	3	3.2	2.6	3.0	0.4	2.5
	4.0	2.5	0.7	0.9	1.0	0.4	15.2	6.3	9.7			1.7	0.4	13.5	2.79		3.0	2.3	2.6		

- Notes
1. Terminal dimensions within this zone are uncontrolled
 2. Dot lines area designs may vary
 3. Eject pin mark is for reference only

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT186A		3 LEADS TO220F				2013-11-14

12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 09 April 2025